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REISSUE APPLICATION DECLARATION BY THE INVENTOR	Docket Number (optional) 740756-1834
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As a below named inventor, I hereby declare that:
My residence, mailing address and citizenship are stated below next to my name.
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is described and claimed in patent number 6,071,766, granted June 6, 2000, and for which a reissue patent is sought on the invention entitled METHOD FOR FABRICATING SEMICONDUCTOR THIN FILM

_____ ,
the specification of which

☐ is attached hereto.
☒ was filed on April 20, 2001 as reissue application number 09/838,216
and was amended on _____.
(If applicable)

I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.
I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.
I verily believe the original patent to be wholly or partly inoperative or invalid, for the reasons described below.
(Check all boxes that apply.)

☐ by reason of a defective specification or drawing.
☒ by reason of the patentee claiming more or less than he had the right to claim in the patent.
☐ by reason of other errors.

At least one error upon which reissue is based is described below. If the reissue is a broadening reissue, such must be stated with an explanation as to the nature of the broadening:

Applicant's inadvertently included the feature of the silicon nitride as an etching stopper in the claims of the original patent. This feature is not necessary for patentability and narrows the claims below a scope which the inventors had a right to claim in the patent. This feature is not recited in the new independent claims of this reissue patent application.

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(REISSUE APPLICATION DECLARATION BY THE INVENTOR, page 2)

Docket Number (optional)
740756-1834

All errors corrected in this reissue application arose without any deceptive intention on the part of the applicant. As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the United States Patent and Trademark Office connected therewith.

Name(s)	Registration Number(s)	Name(s)	Registration Number(s)
Daniel W. Sixbey	20,932	Daniel S. Song	43,143
Stuart J. Friedman	24,312	Marc S. Kaufman	35,212
Charles M. Leedom, Jr.	26,477	James E. Howard	39,715
David S. Safran	27,997	Corinne R. Gorski	34,339
Thomas W. Cole	28,290	Kenneth H. Salen	43,077
Donald R. Studebaker	32,815	Jason H. Vick	45,285
Jeffrey L. Costellia	35,483	Carolyn Baumgardner	41,345
Tim L. Brackett, Jr.	36,092	Luan C. Do	38,434
Eric J. Robinson	38,285		

Correspondence Address: Direct all communications about the application to:

☒ Customer Number

22204

Type Customer Number here

Place Customer Number Bar
Code Label here

☒ Firm or
Individual Name

NIXON PEABODY LLP

Address

8180 Greensboro Drive

Address

Suite 800

City

McLean

State

VA

Zip

22102

Country

USA

Telephone

(703) 790-9110

Fax

(703) 883-0370

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine and imprisonment, or both, under 18 U.S.C. 1001, and that such willful false statements may jeopardize the validity of the application, any patent issuing thereon, or any patent to which this declaration is directed.

Full name of sole or first inventor (given name, family name): Shunpei YAMAZAKI

Inventor's signature

Date 08/07/2001

Residence: Tokyo, Japan

Citizenship: Japanese

Mailing Address: 10-20, Seijo 4-chome, Setagaya-ku, Tokyo 157-0066 Japan

Full name of second joint inventor (given name, family name): Hisashi OHTANI

Inventor's signature

Date 08/07/2001

Residence: Kanagawa, Japan

Citizenship: Japanese

Mailing Address: Mac Aikoishida Court 501, 7-896-1, Takamori, Isehara-shi, Kanagawa-ken 259-1114 Japan

Full name of third joint inventor (given name, family name): Akiharu MIYANAGA

Inventor's signature

Date 08/07/2001

Residence: Kanagawa, Japan

Citizenship: Japanese

Mailing Address: 2-505, 3-4-1, Minamigaoka, Hadano-shi, Kanagawa-ken, 257-0013 Japan

☒ Additional joint inventors are named on separately numbered sheets attached hereto.

(REISSUE APPLICATION DECLARATION BY THE INVENTOR, page 2)

Docket Number (optional)

740756-1834

Additional joint inventors

Full name of fourth joint inventor (given name, family name): Satoshi TERAMOTO

Inventor's signature SATOSHI TERAMOTO

Date 08/11/2001

Residence: Kanagawa, Japan

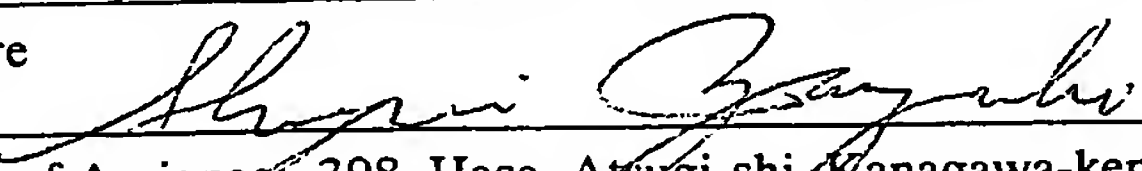
Citizenship: Japanese

Mailing Address: 2-11, Ryosei 3-chome, Ayase-shi, Kanagawa-ken 252-1126 Japan

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REISSUE APPLICATION DECLARATION BY THE ASSIGNEE		Docket Number (optional) 740756-1834
<p>I hereby declare that:</p> <p>My residence and mailing address and citizenship are stated below next to my name.</p> <p>I am authorized to act on behalf of the following assignee: <u>Semiconductor Energy Laboratory Co., Ltd.</u></p> <p>and the title of my position with said assignee is: <u>President</u></p> <p>The entire title to the patent identified below is vested in said assignee.</p>		
Name of Patentee(s): <u>YAMAZAKI et al.</u>		
Patent Number <u>6,071,766</u>	Date of Patent Issued <u>June 6, 2000</u>	
Title of Invention <u>METHOD FOR FABRICATING SEMICONDUCTOR THIN FILM</u>		
<p>I believe said patentee(s) to be the original, first and sole/joint inventor(s) of the subject matter which is described and claimed in said patent, for which a reissue patent is sought on the invention entitled</p> <p><u>METHOD FOR FABRICATING SEMICONDUCTOR THIN FILM</u></p> <p>the specification of which</p> <p><input type="checkbox"/> is attached hereto.</p> <p><input checked="" type="checkbox"/> was filed on <u>April 20, 2001</u> as reissue application number <u>09/ 838,216</u> and was amended on _____ (if applicable)</p> <p>I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.</p> <p>I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.</p> <p>I verify believe the original patent to be wholly or partly inoperative or invalid, for the reasons described below. (Check all boxes that apply.)</p> <p><input type="checkbox"/> by reason of a defective specification or drawing.</p> <p><input checked="" type="checkbox"/> by reason of the patentee claiming more or less than he had the right to claim in the patent.</p> <p><input type="checkbox"/> by reason of other errors.</p> <p>At least one error upon which reissue is based is described as follows:</p> <p>Applicant's inadvertently included the feature of the silicon nitride as an etching stopper in the claims of the original patent. This feature is not necessary for patentability and narrows the claims below a scope which the inventors had a right to claim in the patent. This feature is not recited in the new independent claims of this reissue patent application.</p> <p>[Attach additional sheets, if needed.]</p> <p>All errors corrected in this reissue application arose without any deceptive intention on the part of the applicant.</p>		

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REISSUE APPLICATION DECLARATION BY THE ASSIGNEE				Docket Number (optional) 740756-1834			
I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the United States Patent and Trademark Office connected therewith.							
Name(s)		Registration Number(s)		Name(s)		Registration Number(s)	
Daniel W. Sixbey		20,932		Daniel S. Song		43,143	
Stuart J. Friedman		24,312		Marc S. Kaufman		35,212	
Charles M. Leedom, Jr.		26,477		James E. Howard		39,715	
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Thomas W. Cole		28,290		Kenneth H. Salen		43,077	
Donald R. Studebaker		32,815		Jason H. Vick		45,285	
Jeffrey L. Costellia		35,483		Carolyn Baumgardner		41,345	
Tim L. Brackett, Jr.		36,092		Luan C. Do		38,434	
Eric J. Robinson		38,285					
Correspondence Address: Direct all communications about the application to:							
<input checked="" type="checkbox"/> Customer Number		22204		→		Place Customer Number Bar Code Label Here	
		Type Customer Number Here					
OR							
<input checked="" type="checkbox"/> Firm or Individual Name		NIXON PEABODY LLP					
Address		8180 Greensboro Drive					
Address		Suite 800					
City		McLean		State		VA Zip 22102	
Country		USA					
Telephone		(703) 790-9110		Fax		(703) 883-0370	
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine and imprisonment, or both, under 18 U.S.C. 1001, and that such willful false statements may jeopardize the validity of the application, any patent issuing thereon, or any patent to which this declaration is directed.							
Full name of person signing (given name, family name): Shunpei YAMAZAKI							
Signature 				Date		08/07/2001	
Address of Assignee: 398, Hase, Atsugi-shi, Kanagawa-ken 243-0036, Japan							
Patentee Shunpei YAMAZAKI				Citizenship Japanese			
Residence/Mailing Address 10-20, Seijo 4-chome, Setagaya-ku, Tokyo 157-0066 Japan							
Patentee Hisashi OHTANI				Citizenship Japanese			
Residence/Mailing Address Mac Aikoishida Court 501, 7-896-1, Takamori, Isehara-shi, Kanagawa-ken 259-1114 Japan							
<input checked="" type="checkbox"/> Additional Patentees are named on separately numbered sheets attached hereto.							

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REISSUE APPLICATION DECLARATION BY THE ASSIGNEE		Docket Number (optional) 740756-1834
Patentee Akiharu MIYANAGA		Citizenship Japanese
Residence/Mailing Address 2-505,3-4-1, Minamigaoka, Hadano-shi, Kanagawa-ken, 257-0013 Japan		
Patentee Satoshi TERAMOTO		Citizenship Japanese
Residence/Mailing Address 2-11, Ryosei 3-chome, Ayase-shi, Kanagawa-ken 252-1126 Japan		

STATEMENT UNDER 37 CFR 3.73(b)Applicant/Patent Owner: Semiconductor Energy Laboratory, Inc.Application No./Patent No.: 09/838,216 Filed/Issue Date: April 20, 2001Entitled: METHOD FOR FABRICATING SEMICONDUCTOR THIN FILMSemiconductor Energy Laboratory, Inc., a Corporation,
(Name of Assignee) (Type of Assignee, e.g., corporation, partnership, university, government agency, etc.)

states that it is:

1. ☒ the assignee of the entire right, title, and interest; or
2. ☐ an assignee of less than the entire right, title and interest.
The extent (by, percentage) of its ownership interest is _____%

in the patent application/patent identified above by virtue of either:

- A. ☒ An assignment from the inventor(s) of the patent application/patent identified above. The assignment was recorded in the United States Patent and Trademark Office at Reel 7701, Frame 0233, or for which a copy thereof is attached.

OR

- B. ☐ A chain of title from the inventor(s), of the patent application/patent identified above, to the current assignee as shown below:

1. From: _____ To: _____
The document was recorded in the United States Patent and Trademark Office at Reel _____, Frame _____, or for which a copy thereof is attached.
2. From: _____ To: _____
The document was recorded in the United States Patent and Trademark Office at Reel _____, Frame _____, or for which a copy thereof is attached.
3. From: _____ To: _____
The document was recorded in the United States Patent and Trademark Office at Reel _____, Frame _____, or for which a copy thereof is attached.

☐ Additional documents in the chain of title are listed on a supplemental sheet.

- ☒ Copies of assignments or other documents in the chain of title are attached.

[NOTE: A separate copy (i.e., the original assignment document or true copy of the original document) must be submitted to Assignment Division in accordance with 37 CFR Part 3, if the assignment is to be recorded in the records of the USPTO. See MPEP 302.08]

The undersigned (whose title is supplied below) is authorized to act on behalf of the assignee.

08/20/2001
Date

Shunpei YAMAZAKI
Typed or printed name


Signature

President
Title

Burden Hour Statement: This form is estimated to take 0.2 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, Washington, DC 20231.